

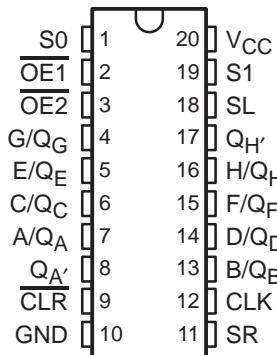
The SN54F299 is obsolete and no longer supplied.

# SN54F299, SN74F299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS WITH 3-STATE OUTPUTS

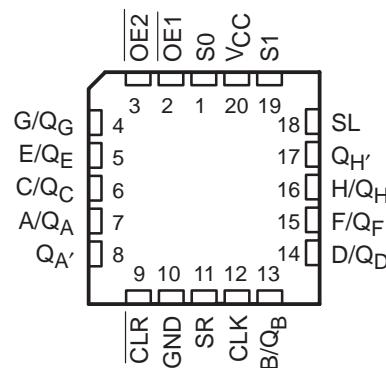
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- Four Modes of Operation:
  - Hold (Store)
  - Shift Right
  - Shift Left
  - Load Data
- Operates With Outputs Enabled or at High Impedance
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Direct Overriding Clear
- Applications:
  - Stacked or Pushdown Registers
  - Buffer Storage
  - Accumulator Registers

SN54F299 . . . J PACKAGE  
SN74F299 . . . DW, N, OR NS PACKAGE  
(TOP VIEW)



SN54F299 . . . FK PACKAGE  
(TOP VIEW)



## description/ordering information

These 8-bit universal shift/storage registers feature multiplexed I/O ports to achieve full 8-bit data handling in a single 20-pin package. Two function-select (S0, S1) inputs and two output-enable ( $\overline{OE}_1$ ,  $\overline{OE}_2$ ) inputs can be used to choose the modes of operation listed in the function table.

Synchronous parallel loading is accomplished by taking both S0 and S1 high. This places the 3-state outputs in a high-impedance state and permits data that is applied on the I/O ports to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. Clearing occurs when the clear (CLR) input is low. Taking either  $\overline{OE}_1$  or  $\overline{OE}_2$  high disables the outputs but has no effect on clearing, shifting, or storage of data.

## ORDERING INFORMATION

TA	PACKAGE <sup>†</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube of 20	SN74F299N	SN74F299N
	SOIC – DW	Tube of 25	SN74F299DW	F299
		Reel of 2000	SN74F299DWR	
	SOP – NS	Reel of 2000	SN74F299NSR	74F299

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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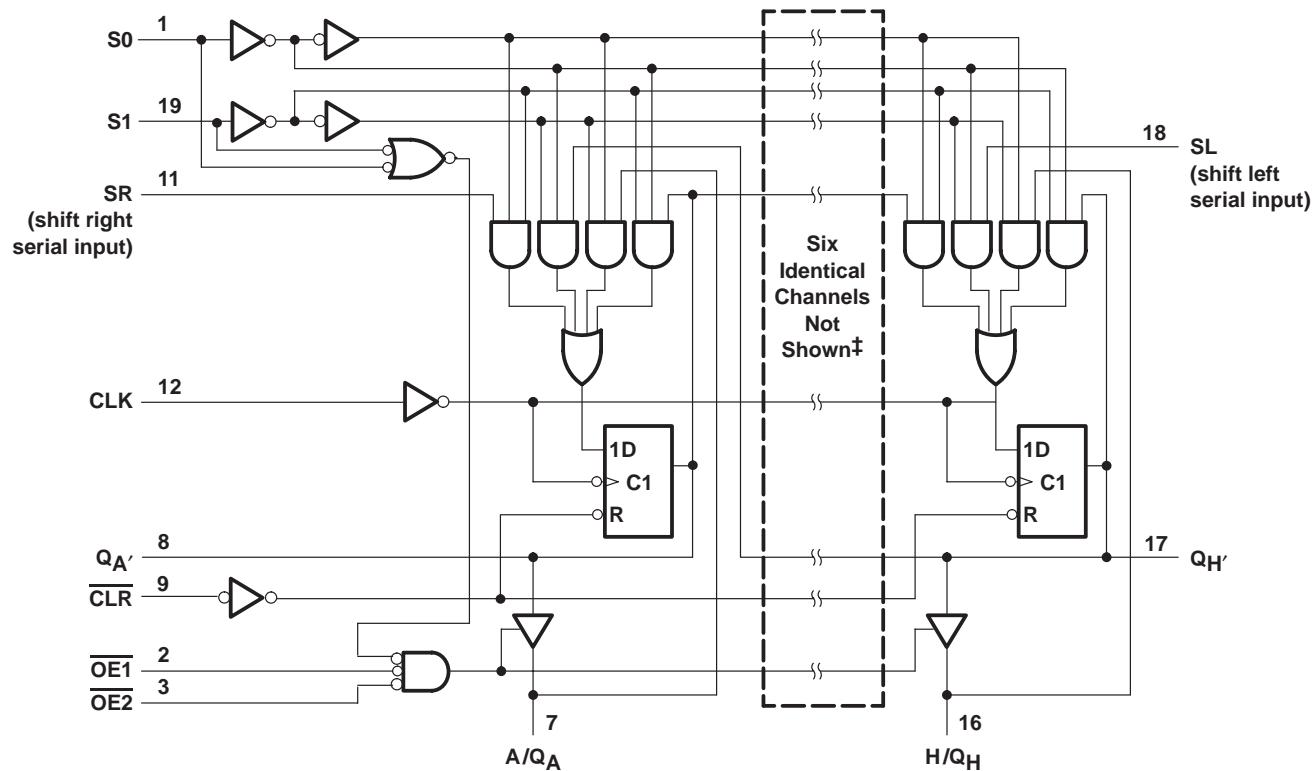
## FUNCTION TABLE

Mode	Inputs								I/O Ports								Outputs	
	CLR	S1	S0	OE1†	OE2†	CLK	SL	SR	A/Q <sub>A</sub>	B/Q <sub>B</sub>	C/Q <sub>C</sub>	D/Q <sub>D</sub>	E/Q <sub>E</sub>	F/Q <sub>F</sub>	G/Q <sub>G</sub>	H/Q <sub>H</sub>	Q <sub>A'</sub>	Q <sub>H'</sub>
Clear	L	X	L	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
	L	L	X	L	L	X	X	X	L	L	L	L	L	L	L	L	L	L
	L	H	H	X	X	X	X	X	X	X	X	X	X	X	X	X	L	L
Hold	H	L	L	L	L	X	X	X	QA <sub>0</sub>	QB <sub>0</sub>	QC <sub>0</sub>	QD <sub>0</sub>	QE <sub>0</sub>	QF <sub>0</sub>	QG <sub>0</sub>	QH <sub>0</sub>	QA <sub>0</sub>	QH <sub>0</sub>
	H	X	X	L	L	L	X	X	QA <sub>0</sub>	QB <sub>0</sub>	QC <sub>0</sub>	QD <sub>0</sub>	QE <sub>0</sub>	QF <sub>0</sub>	QG <sub>0</sub>	QH <sub>0</sub>	QA <sub>0</sub>	QH <sub>0</sub>
Shift Right	H	L	H	L	L	↑	X	H	H	QAn	QBn	QCn	QDn	QE <sub>n</sub>	QFn	QGn	H	QGn
	H	L	H	L	L	↑	X	L	L	QAn	QBn	QCn	QDn	QE <sub>n</sub>	QFn	QGn	L	QGn
Shift Left	H	H	L	L	L	↑	H	X	QBn	QCn	QDn	QE <sub>n</sub>	QFn	QGn	QHn	H	QBn	H
	H	H	L	L	L	↑	L	X	QBn	QCn	QDn	QE <sub>n</sub>	QFn	QGn	QHn	L	QBn	L
Load	H	H	H	X	X	↑	X	X	a	b	c	d	e	f	g	h	a	h

NOTE: a . . . h = the level of the steady-state input at inputs A through H, respectively. This data is loaded into the flip-flops while the flip-flop outputs are isolated from the I/O terminals.

† When one or both output-enable inputs are high, the eight I/O terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

## logic diagram (positive logic)



† I/O ports not shown: B/Q<sub>B</sub> (13), C/Q<sub>C</sub> (6), D/Q<sub>D</sub> (14), E/Q<sub>E</sub> (5), F/Q<sub>F</sub> (15), and G/Q<sub>G</sub> (4).

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input voltage ratings may be exceeded provided the input current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JEDEC 51-7.

### **recommended operating conditions (see Note 3)**

		SN54F299			SN74F299			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage		2		2			V
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V
I <sub>IK</sub>	Input clamp current			-18			-18	mA
I <sub>OH</sub>	High-level output current	Q <sub>A'</sub> or Q <sub>H'</sub>		-1			-1	mA
		Q <sub>A</sub> thru Q <sub>H</sub>		-3			-3	
I <sub>OL</sub>	Low-level output current	Q <sub>A'</sub> or Q <sub>H'</sub>		20		20		mA
		Q <sub>A</sub> thru Q <sub>H</sub>		20		24		
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**SN54F299, SN74F299  
8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS  
WITH 3-STATE OUTPUTS**

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longer supplied.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	SN54F299			SN74F299			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
V <sub>IK</sub>	V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA			-1.2			-1.2	V
V <sub>OH</sub>	Q <sub>A</sub> ' or Q <sub>H</sub> ' V <sub>CC</sub> = 4.5 V Q <sub>A</sub> thru Q <sub>H</sub>	I <sub>OH</sub> = -1 mA	2.5	3.4	2.5	3.4		V
		I <sub>OH</sub> = -1 mA	2.5	3.4	2.5	3.4		
		I <sub>OH</sub> = -3 mA	2.4	3.3	2.4	3.3		
Any output	V <sub>CC</sub> = 4.75 V, I <sub>OH</sub> = -1 mA to -3 mA				2.7			
V <sub>OL</sub>	Q <sub>A</sub> ' or Q <sub>H</sub> ' V <sub>CC</sub> = 4.5 V Q <sub>A</sub> thru Q <sub>H</sub>	I <sub>OL</sub> = 20 mA	0.3	0.5	0.3	0.5		V
		I <sub>OL</sub> = 20 mA	0.3	0.5				
		I <sub>OL</sub> = 24 mA			0.35	0.5		
I <sub>I</sub>	A thru H V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 5.5 V		1		1		mA
		V <sub>I</sub> = 7 V		0.1		0.1		
I <sub>IH</sub> ‡	A thru H V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 2.7 V		70		70			µA
			20		20			
I <sub>IL</sub> ‡	A thru H S0 or S1 V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 0.5 V		-0.65		-0.65			mA
			-1.2		-1.2			
			-0.6		-0.6			
I <sub>OS</sub> §	V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0		-60	-150	-60	-150		mA
I <sub>CC</sub>	V <sub>CC</sub> = 5.5 V, See Note 4		68	95	68	95		mA

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

‡ For I/O ports (Q<sub>A</sub> thru Q<sub>H</sub>), the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 4: I<sub>CC</sub> is measured with OE1, OE2, and CLK at 4.5 V.

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		SN54F299		SN74F299		UNIT	
			'F299							
			MIN	MAX	MIN	MAX	MIN	MAX		
f <sub>clock</sub>	Clock frequency			70		65		70	MHz	
t <sub>w</sub>	Pulse duration	CLK high or low			7	8	7		ns	
		CLR low			7	8	7			
t <sub>su</sub>	Setup time before CLK↑	S0 or S1	High or low	8.5	9.5	8.5			ns	
		A/Q <sub>A</sub> thru H/Q <sub>H</sub> , SR, or SL	High or low	5.5	6.5	5.5				
t <sub>h</sub>	Hold time after CLK↑	CLR	High	7	13	7			ns	
		S0 or S1	High or low	0	0	0				
		A/Q <sub>A</sub> thru H/Q <sub>H</sub> , SR, or SL	High or low	2	2	2				

¶ Inactive-state setup time also is referred to as recovery time.

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**WITH 3-STATE OUTPUTS**

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = 25°C			V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = MIN to MAX <sup>†</sup>			UNIT	
			'F299			SN54F299		SN74F299		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			70	100		65		70		MHz
t <sub>PLH</sub>	CLK	Q <sub>A'</sub> or Q <sub>H'</sub>	3.2	6.6	9	2.7	10.5	3.2	10	ns
t <sub>PHL</sub>			2.7	6.1	8.5	2.2	10	2.7	9.5	
t <sub>PLH</sub>	CLK	Q <sub>A</sub> thru Q <sub>H</sub>	3.2	6.6	9	2.7	11	3.2	10	ns
t <sub>PHL</sub>			4.2	8.1	11	3.7	12.5	4.2	12	
t <sub>PHL</sub>	CLR	Q <sub>A'</sub> or Q <sub>H'</sub>	3.7	7.1	9.5	3.2	11.5	3.7	10.5	ns
		Q <sub>A</sub> thru Q <sub>H</sub>	5.7	10.6	14	5	15.5	5.7	15	
t <sub>PZH</sub>	OE1 or OE2	Q <sub>A</sub> thru Q <sub>H</sub>	2.7	5.6	8	2.2	10.5	2.7	9	ns
t <sub>PZL</sub>			3.2	6.6	10	2.7	12	3.2	11	
t <sub>PHZ</sub>	OE1 or OE2	Q <sub>A</sub> thru Q <sub>H</sub>	1.7	4.1	6	1.7	9	1.7	7	ns
t <sub>PLZ</sub>			1.2	3.6	5.5	1.2	7.5	1.2	6.5	

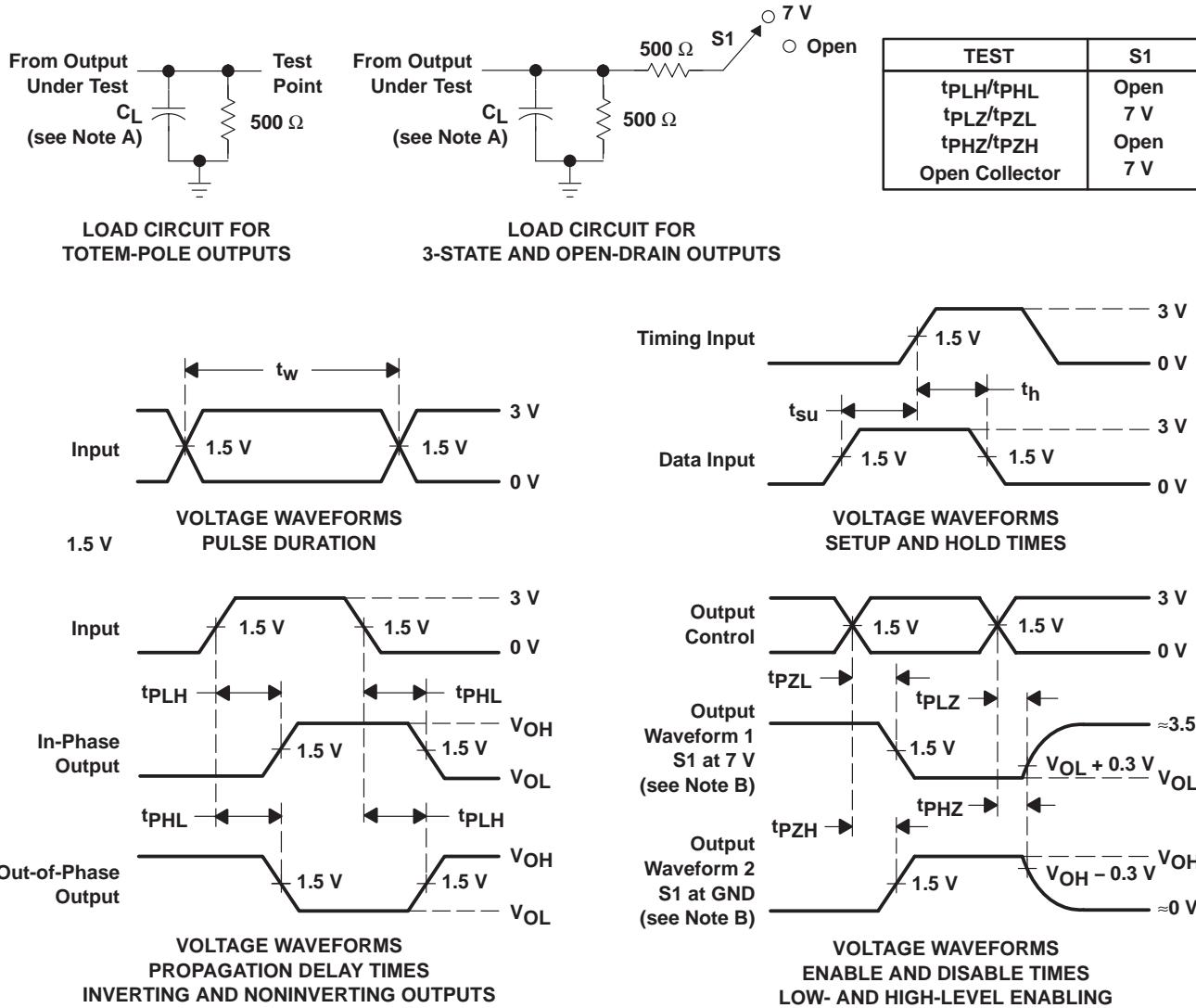
<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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**PARAMETER MEASUREMENT INFORMATION**



NOTES:

- $C_L$  includes probe and jig capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR  $\leq 1$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns, duty cycle = 50%.
- The outputs are measured one at a time, with one input transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN74F299DW</a>	Obsolete	Production	SOIC (DW)   20	-	-	Call TI	Call TI	0 to 70	F299
<a href="#">SN74F299DWR</a>	Active	Production	SOIC (DW)   20	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F299
SN74F299DWR.A	Active	Production	SOIC (DW)   20	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F299
<a href="#">SN74F299N</a>	Active	Production	PDIP (N)   20	20   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F299N
SN74F299N.A	Active	Production	PDIP (N)   20	20   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F299N
SN74F299NS.A	Active	Production	SOP (NS)   20	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74F299

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

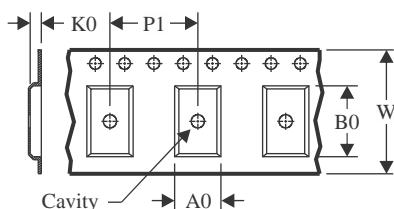
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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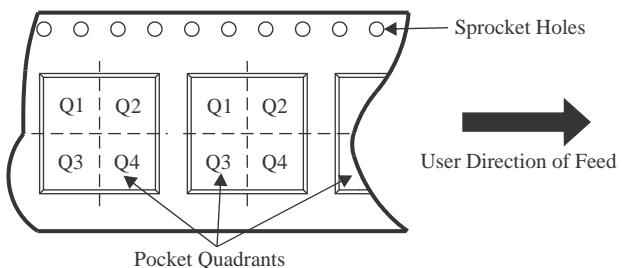
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**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

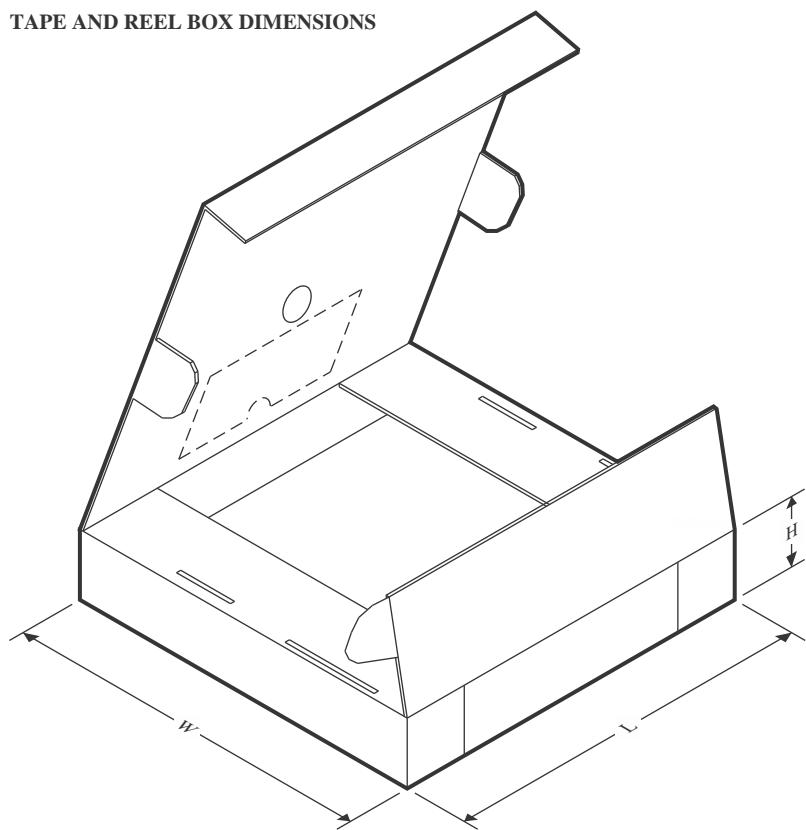
**TAPE DIMENSIONS**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F299DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F299DWR	SOIC	DW	20	2000	356.0	356.0	45.0

**TUBE**


\*All dimensions are nominal

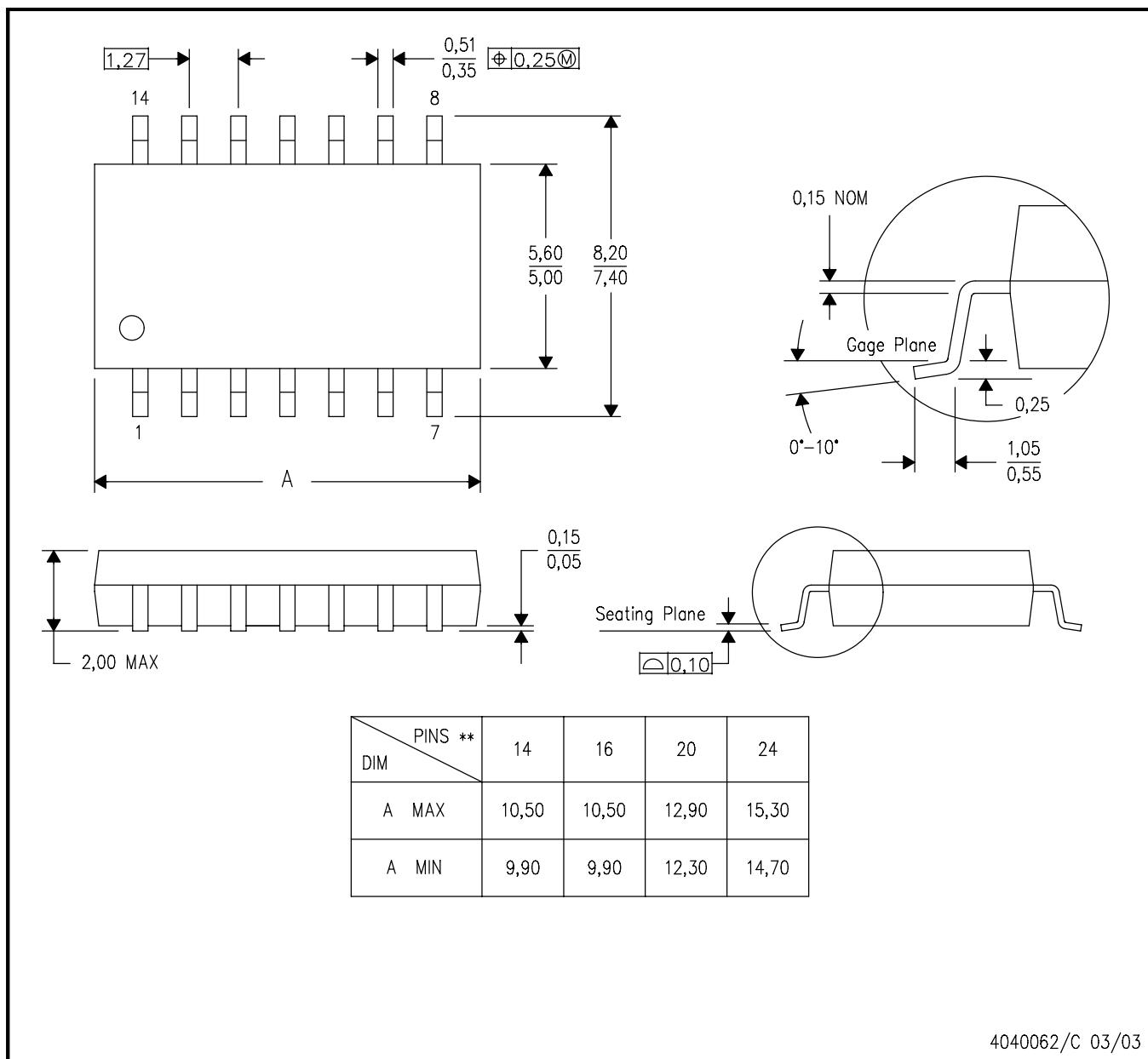
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74F299N	N	PDIP	20	20	506	13.97	11230	4.32
SN74F299N.A	N	PDIP	20	20	506	13.97	11230	4.32
SN74F299NS.A	NS	SOP	20	40	530	10.5	4000	4.1

## MECHANICAL DATA

NS (R-PDSO-G\*\*)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



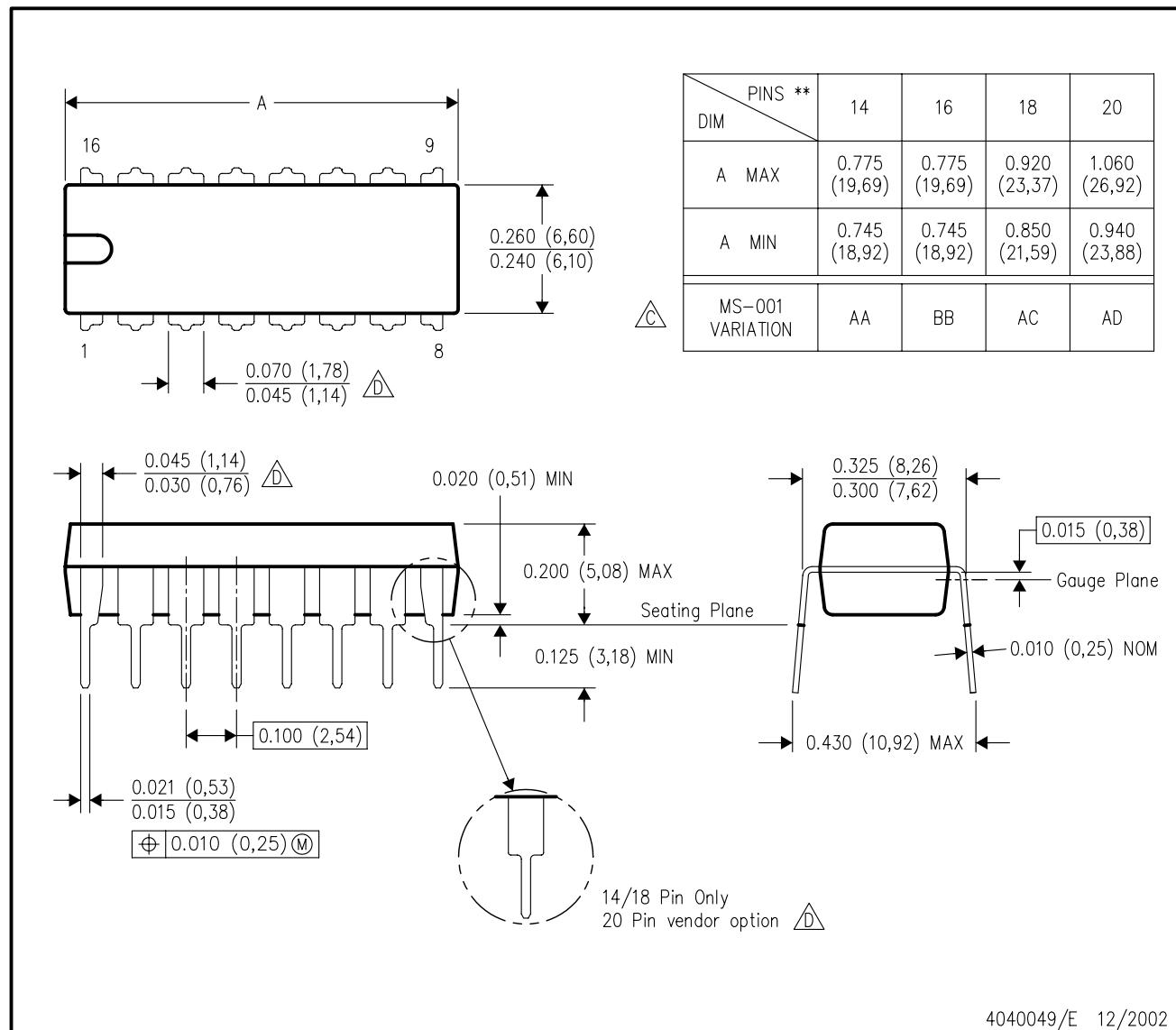
NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

4040062/C 03/03

N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.

B. This drawing is subject to change without notice.

 Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

 The 20 pin end lead shoulder width is a vendor option, either half or full width.

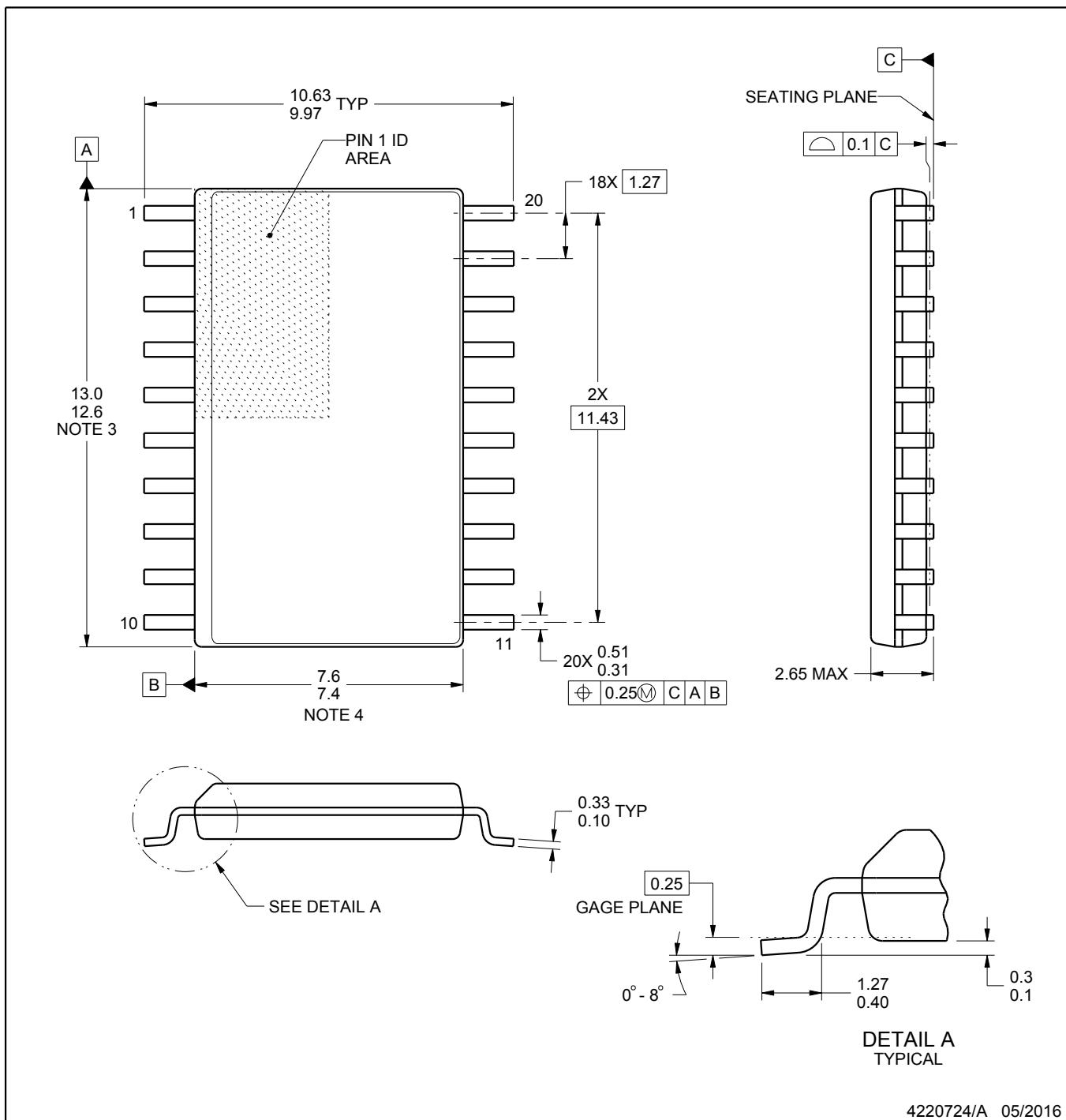
# PACKAGE OUTLINE

DW0020A



SOIC - 2.65 mm max height

SOIC



## NOTES:

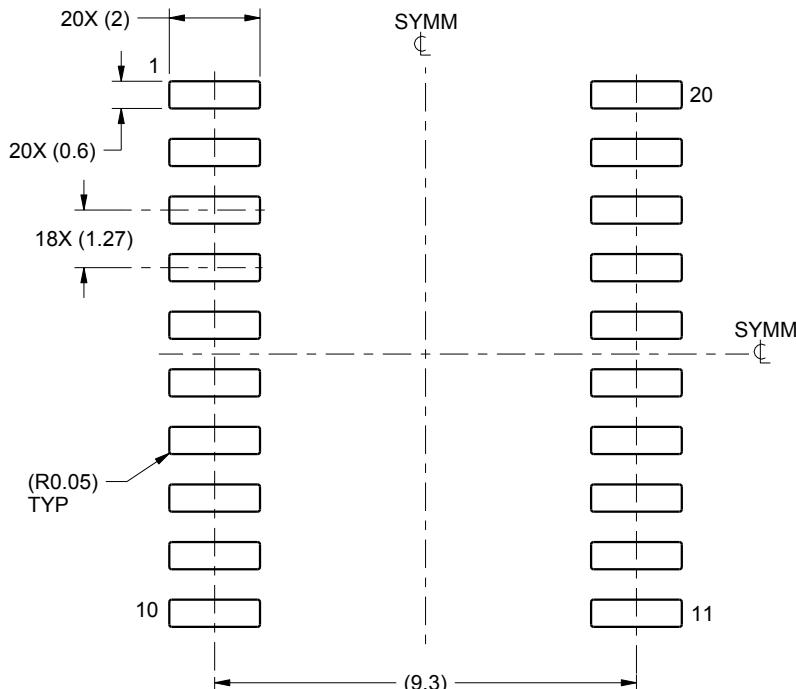
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

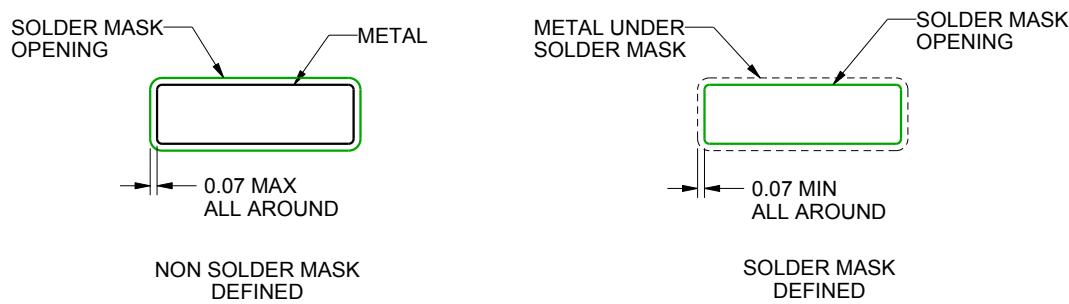
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

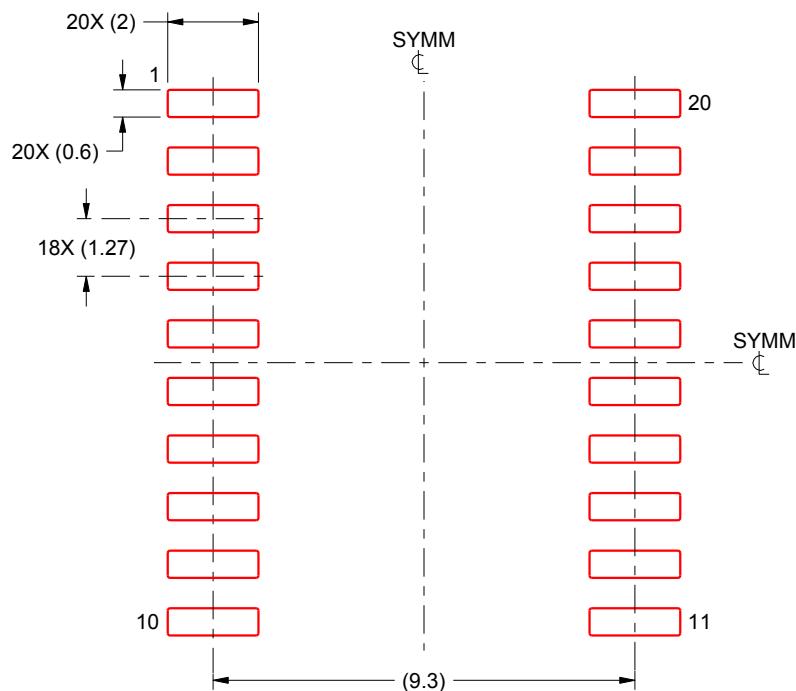
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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